# 502721234 03/13/2014

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
TOMOATSU ISHIBASHI	03/06/2014

## **RECEIVING PARTY DATA**

Name:	EBARA CORPORATION		
Street Address:	11-1, HANEDA ASAHI-CHO, OHTA-KU		
City:	TOKYO		
State/Country:	JAPAN		

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14197101

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	101716.000062
NAME OF SUBMITTER:	ROZELL PRICE FISCHER
SIGNATURE:	/Rozell Price Fischer/
DATE SIGNED:	03/13/2014

## **Total Attachments: 2**

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PATENT 502721234 REEL: 032434 FRAME: 0170

DOCKET NO.: 101716.000062

#### ASSIGNMENT

WHEREAS, I, Tomoatsu ISHIBASHI, a citizen of Japan, residing at c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number 101716.000062 ("the invention"), which is entitled "SURFACE POTENTIAL MEASURING APPARATUS AND SURFACE POTENTIAL MEASURING METHOD" ("the subject application"), and which claims priority to Japanese patent application number 2013-044267 filed March 6, 2013 ("the priority application"). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, EBARA CORPORATION, ASSIGNEE, having a place of business at 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming

# DOCKET NO.: 101716.000062

the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

	TIMONY W	HEREOF,	I have sign	ed my nan	ne below on the	date indicated above	
my signature.							
Executed this _	6th	day of _	March	, year	of 2014.		
Tomocotzu	Ishibas	hi					
Signature (Tom	oatsu ISHIE	SASHI)					
*****	******	******	*****	*******	******	*******	
STATEMENT SIGNED at							
(City)			(Coun	try)			
This day	of		, 201				
I,					whose full		
residence addre	ss is					· · · · · · · · · · · · · · · · · · ·	
was personally	present and	did see		ex	xecute the abov	re assignment on the	
day of person describe			l, and suc	ch assignor	is personally k	nown to me to be the	
	a in buon do						
Signature of Wi	tness						
*****	*******	******	*******	******	******	******	
The foregoing a March 4, 2014		overs pate	nt application	on number	14/197,101	, filed on	
		/Michael J. Swope/					
		Registra	f Attorney: tion No.:	Michael 38,041 March 1	J. Swope		

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